

# **US1A THRU US1M**

## SURFACE MOUNT HIGH EFFICIENCY RECTIFIER

Reverse Voltage - 50 to 1000 Volts Forward Current - 1.0 Ampere

## FEATURES

◆Plastic package has underwrites laboratory

flammability

Classification 94V-0

- ◆Built-in strain relief, ideal for automated placement
- ◆Glass Passivated chip junction
- ◆Fast switching speed for high efficiency
- ◆High temperature soldering guaranteed:

260°C/10 second

### **Mechanical Data**

◆Case: JEDED DO-214AC molded plastic over

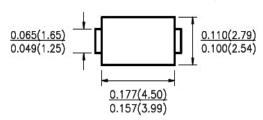
glass passivated chip

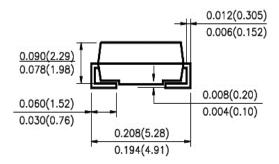
◆Terminals: Solder plated, Solderable per

MIL-STD-750, Method 2026

◆Polarity: Color band denotes cathode end

# DO-214AC (SMA)





**Dimensions in inches and (millimeters)** 

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

PARAMETER		SYMBOL	US1A	US1B	US1D	US1G	US1J	US1K	US1M	UNIT
Maximum Repetitive Peak Reverse Voltage		$V_{RRM}$	50	100	200	400	600	800	1000	VOLTS
Maximum RMS Voltage		V <sub>RMS</sub>	35	70	140	280	420	560	700	VOLTS
Maximum DC Blocking Voltage		V <sub>DC</sub>	50	100	200	400	600	800	1000	VOLTS
Maximum Average Forward Rectified Current At $T_A$ =55 $^{\circ}$ C		I <sub>(AV)</sub>	1.0							Amps
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)		Ігэм	30						Amps	
Maximum instantaneous forward voltage per at 1.0A		$V_{F}$	1.0 1.30 1.70					VOLTS		
Maximum DC Reverse Current at Rated DC blocking voltage	T <sub>A</sub> =25℃		5.0							uA
	T <sub>A</sub> =125℃	<b>I</b> R	100							
Maximum Reverse Recovery Time Test conditions I <sub>F</sub> =0.5A, I <sub>R</sub> =1.0A, I <sub>RR</sub> =0.25A		t <sub>rr</sub>		50			100			nS
Typical Junction Capacitance (Measured at 1.0MHz and applied reverse voltage of 4.0V)		С		20			15			pF
Typical Thermal Resistance (Note 1)		RөJA	88							- ℃W
		Røjl	28							
Operating Junction Temperature		TJ	-55 to +150							$^{\circ}$ C
Storage Temperature Rang		Тѕтс	-55 to +150						$^{\circ}$ C	

Note: 1. Thermal resistance from Junction to ambient and from junction to lead mounted on P.C.B. with  $0.2 \times 0.2''$  ( $5.0 \times 5.0$ mm) copper pad areas.

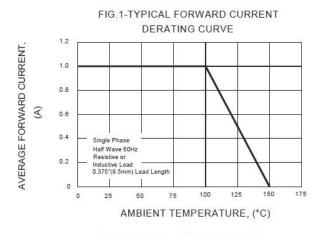


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### RATING AND CHARACTERISTIC CURVES US1A THRU US1M





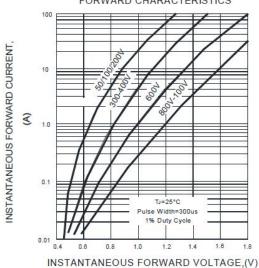
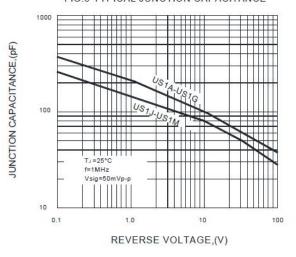
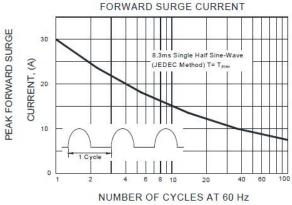


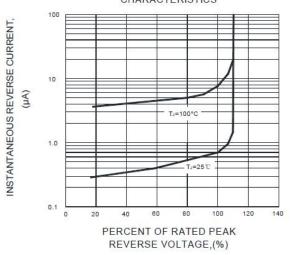
FIG.5-TYPICAL JUNCTION CAPACITANCE



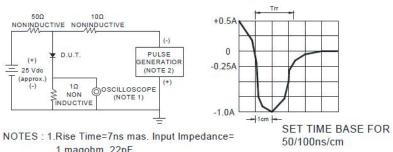
### FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



#### FIG.4-TYPICAL REVERSE CHARACTERISTICS



#### F1G.6-TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC



1 magohm. 22pF

2.Rise time=10ns max. Source Impedance= 50 ohms

Note: Specifications are subject to change without notice. For more detail and update, please visit our website.